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Welcome to ICVISP 2025

It is with great pleasure that we invite you to the 2025 9th International Conference on Vision, Image and Signal Processing (ICVISP 2025), which is scheduled to take place from November 28-30, 2025, in Xi'an, China. The conference is organized by Northwestern Polytechnical University and Xi'an University of Posts & Telecommunications, and technically sponsored by Asia-Pacific Signal and Information Processing Association (APSIPA) and IEEE Xi'an Section. ICVISP is committed to delivering a platform for collaboration and discovery, with the aim of driving progress in image, vision, and signal processing—key technologies that are enhancing our understanding of the world and propelling advancements in artificial intelligence, machine learning, and a multitude of other applications that are transforming industries and improving lives. We warmly invite your contributions and eagerly anticipate the opportunity to meet with you in person at ICVISP 2025.

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Call for Papers

For more information, please visit: www.icvisp.org/cfp The topics of interest include, but are not limited to:

Computer Vision

Image Processing

Signal Processing

Multimodal AI

Applications

Sessions

For more information, please visit: www.icvisp.org/spe

Session I - Multimodal Perception, Planning and **Decision-Making**

Session III - Radar System Design and Radar **Target Detection and Perception**

Session V - Low-Quality Image Enhancement and Restoration

Session VII- Sensor Array and Multichannel Signal **Processing**

Session II - Low-Cost Computing and **Perception Methods**

Session IV - Visual, Image and Signal **Processing Innovative Application in the Field of Education**

Session VI - Radar Signal and Information Processing

Session VIII - Advanced Scene Understanding Methods and Applications in Multi-Modal Data

Publication

Registered and presented full papers will be included in the ICVISP 2025 digital conference proceedings (ISBN: 979-8-3315-5682-2), which will be published by IEEE and submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements, and also submitted to major citation databases (including, but not limited to Ei Compendex and Scopus) for review and indexing.



Key Dates

Third Round

Abstract Submission Due: October 19, 2025 Full Submission Due: October 26, 2025 **Notification:** November 5, 2025

Final Paper Submission Due: November 14, 2025 Main Conference: November 28-30, 2025

Registration Due: November 14, 2025

Submission

Online submission link:

https://cmt3.research.microsoft.com/ICVISP2025

Or scan the QR Code:



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